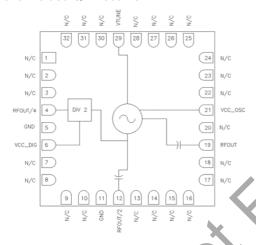


## RFVC1833B

# 8.35GHz to 9.50GHz MMIC VCO with Fo/2 and Fo/4 Outputs

RFMD's RFVC1833B is a 5V InGaP MMIC VCO with an integrated frequency divider providing additional Fo/2 and Fo/4 outputs. With an Fo frequency range of 8.4GHz to 9.6GHz its monolithic structure provides excellent temperature, shock, and vibration performance. Output power (Fo) is +8dBm and is flat across the tuning voltage range of 1.5V to 14.5V. Phase noise is typically -114dBc/Hz at 100kHz offset. The device operates from a low supply current of 245mA which can be further reduced to 185mA by disabling the divider functions if not required. The RFVC1833B is available in a low cost 5mm x 5mm surface mount plastic overmolded QFN outline.



Functional Block Diagram

#### **Ordering Information**

RFVC1833BS2	Sample bag with 2 pieces
RFVC1833BSB	Sample bag with 5 pieces
RFVC1833BSQ	Bag with 25 pieces
RFVC1833BSR	Bag with 100 pieces
RFVC1833BTR7	7" Reel with 750 pieces

RFVC1833BPCBA-410 Evaluation Board



Package: Plastic QFN, 32-pin, 5mm x 5mm x 0.85mm

#### **Features**

- Mu tip. Frequency Outputs
  - F3: 8.35GHz to 9.50GHz10/2: 4.17GHz to 4.75GHz
  - Fo/4: 2.08GHz to 2.37GHz
- No External Resonator Required
- Integrated Frequency Divider
- Phase Noise: -114dBc/Hz at 100kHz Offset
- Flat Output Power Over Frequency Tuning Range 1.5V to 14.5V
  - Fo: 8dBmFo/2: 6dBm
  - Fo/4: -2dBm
- Low Power Consumption
  - 5V/245mA (Divider On)
  - 5V/185mA (Divider Off)
- 32-Lead 5mm x 5mm Plastic Overmolded QFN

#### **Applications**

- Point-to-Point Radio
- Point-to-Multipoint Radio
- Satellite Communications
- Test Equipment
- Military
- Aerospace



#### **Absolute Maximum Ratings**

Parameter	Rating	Unit
V <sub>CC_OSC</sub> , V <sub>CC_DIG</sub>	+5.5	V
V <sub>TUNE</sub>	0 to +15	V
Junction Temperature (T <sub>J</sub> )	135	°C
Continuous P <sub>DISS</sub> (T <sub>A</sub> = 85°C) (derate 37mW/°C above T <sub>A</sub> = 85°C)	1.65	W
Junction to Case, Thermal Resistance (R <sub>θ(j-a)</sub> )	30	°C/W
Storage Temperature	-65 to +150	°C
Operating Temperature	-40 to +85	°C
ESD Sensitivity (HBM)	Class 1A	



Caution! ESD sensitive device.



RFMD Green: RoHS compliant per EU Directive 2011/65/EU, halogen free per IEC 61249-2-21, <1000ppm each of antimony trioxide in polymeric materials and red phosphorus as a flame retardant, and <2% antimony solder.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to an device. Extended application of Absolute Maximum. Rating conditions to the device may reduce device alia. Ility. Specified typical performance or functional operation of the device under Absolute Maximum is ting conditions is not implied.

#### **Nominal Operating Parameters**

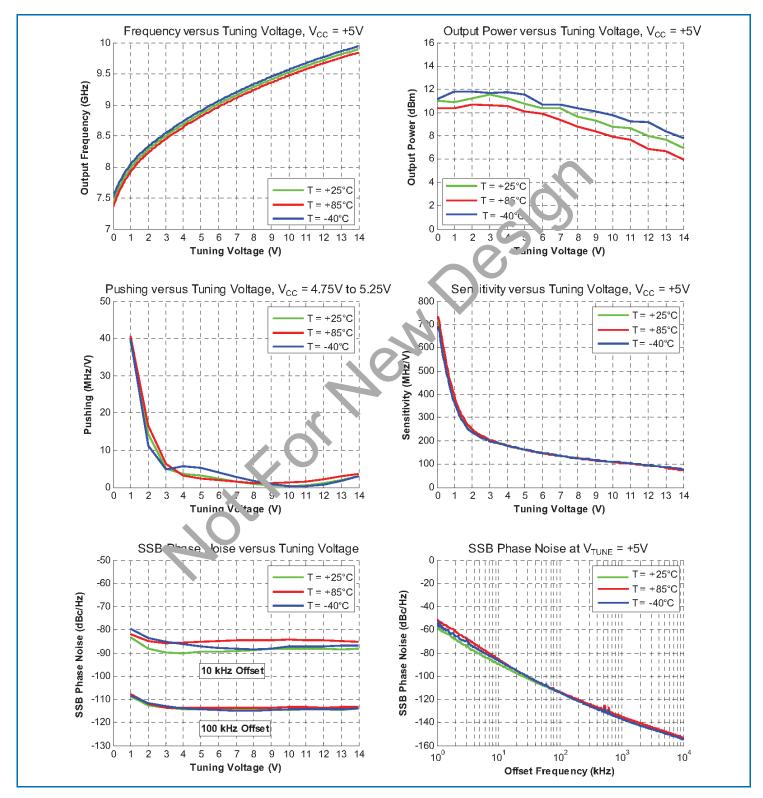
Parameter	Specification		Unit	Condition	
Parameter	Min	Тур	Max	Unit	Condition
Electrical Specifications					V <sub>CC</sub> = 5V, T <sub>A</sub> = +25°C
Operating Frequency					
Fo	8.35		9.50	GHz	
Fo/2	4.17		4.75	GHz	
Fo/4	2.08		2.37	Ti.	
Output Power					
Fo		8		dBm	
Fo/2		6		dBm	
Fo/4				dBm	
SSB Phase Noise					
10kHz offset at RF <sub>OUT</sub>		50		dBc/Hz	V <sub>TUNE</sub> = 5V
100kHz offset at RF <sub>OUT</sub>		-114		dBc/Hz	
Tune Voltage	1.5		14.5	V	
Supply Voltage (Oscillator and Divider)		5		V	
Supply Current					
V <sub>CC_OSC</sub>		185		mA	
V <sub>CC_DIG</sub>		60		mA	
Tune Port Leakage Current		10		μA	
Output Return Loss		6		dB	



Doromotor	Specification			Unit	Our distant
Parameter	Min	Тур	Max	Unit Condition	
Electrical Specifications (continued)					
Harmonics/Sub-harmonics					Measured with RF probes at package, not at SMA connections on EVB
1/2		60		dBc	
3/2		50		dBc	
2 <sup>nd</sup>		15		dBc	
3 <sup>rd</sup>		25		dBc	
Pulling (into a 2.0:1 VSWR)		5		MHz pp	
Pushing		15		MHz/V	401
Frequency Drift Rate		0.8		MHz/°C	Co
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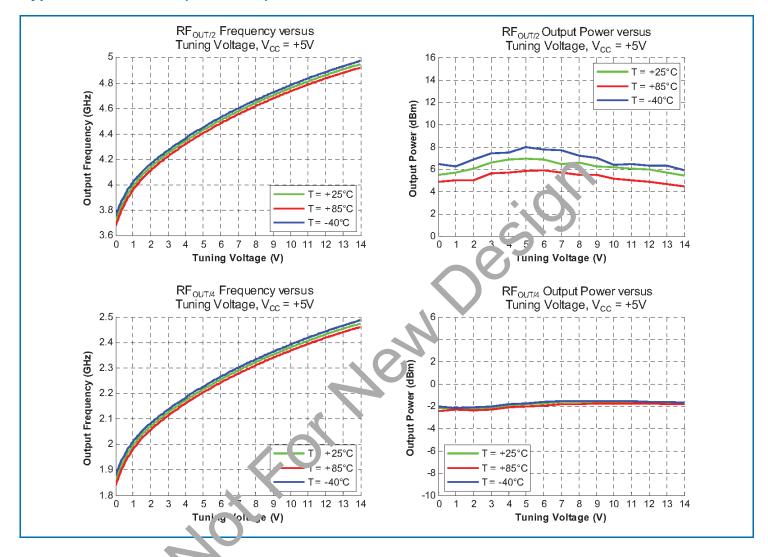


#### **Typical Performance**





#### **Typical Performance (continued)**





#### **Pin Names and Descriptions**

Pin	Name	Description	Interface Schematic
1-3	N/C	No internal connection.	
4	RFOUT/4	VCO RF output at Fo/4. Externally DC-blocked.	5 V RFOUT/4
5	GND	Connect to PCB ground.	GND =
6	VCC_DIG	Supply voltage input for the integrated frequency divider. Typical +5V. Ground this pin to disable digital divider and reduce current consumption by 60mA.	VCC_DIG
7-10	N/C	No internal connection.	
11	GND	Connect to PCB ground.	See Pin 5 interface schematic
12	RFOUT/2	VCO RF output at Fo/2 Internally DC-blocked.	RFOUT/2 •—
13-18	N/C	No internal connection.	
19	RFOUT	VCC 3F output at Fo. Internally DC-blocked.	RFOUT 0-
20	N/C	No internal connection.	
21	VCC_OSC	Supply voltage input for the VCO. Typical +5V.	VCC_OSC

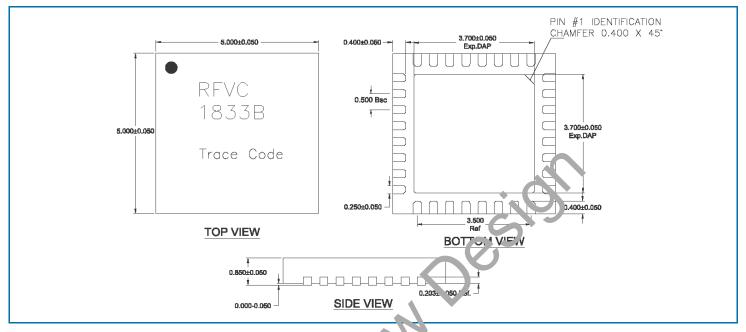


#### **Pin Names and Descriptions (continued)**

Pin	Name	Description	Interface Schematic					
22-28	N/C	No internal connection.						
29	VTUNE	VCO control voltage input.	VTUNE					
30-32	N/C	No internal connection.						
PKG BASE	GND	Connect to PCB ground.	Sca Pin 5 interface schematic					
Hot For Hem Desilor								



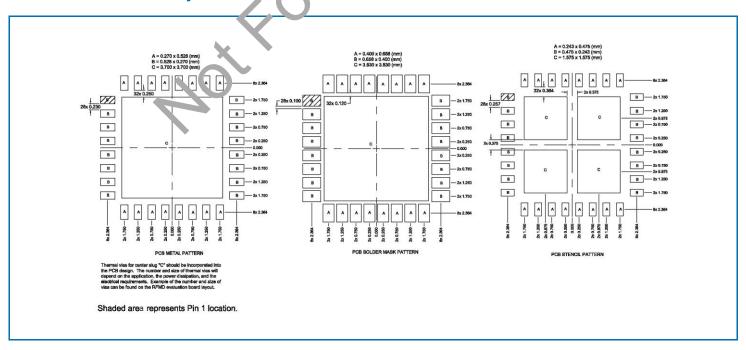
#### Package Drawing (all dimensions in mm)



#### Notes:

- 1. Dimensions are for reference only.
- 2. Package body material: Plastic.
- 3. Lead and paddle plating: 8µm minimum of Sn ov r Cu leadframe.

#### **Recommended PCB Layout**

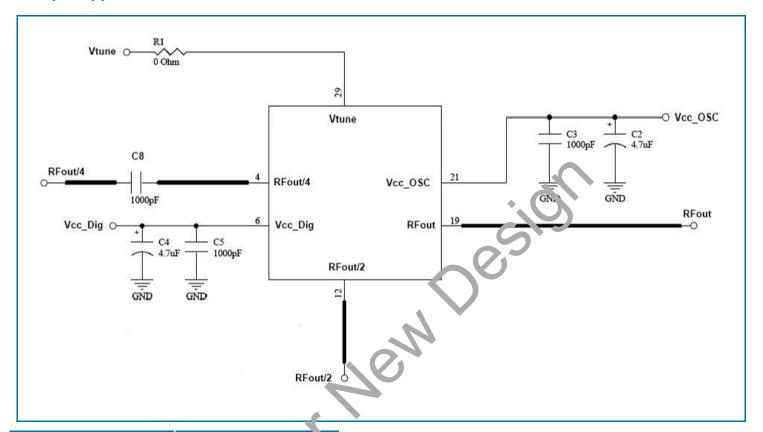


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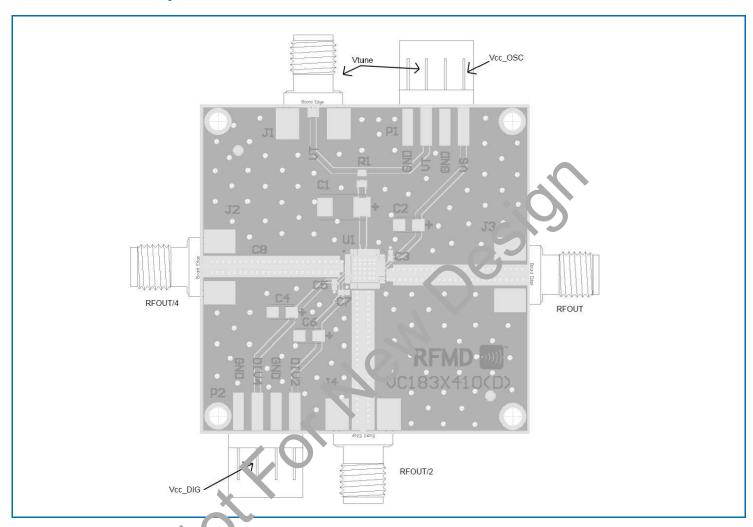
### **Sample Application Circuit Schematic**



Bias Conditions	Output
V <sub>CC_OSC</sub> = 5V	F <sub>OUT</sub> = 8.9GHz
V <sub>CC_DIG</sub> = 5V	F <sub>OUT/2</sub> = 4.45GH <sub>4</sub>
V <sub>TUNE</sub> = 5V	F <sub>OUT/4</sub> = 2.^25GHz



### **Evaluation Board Layout**



## **Evaluation Board Bn or materials (BOM)**

Item	Description
U1	RFVC1833B VCO
C3, C5, C7, C8	1000pF Capacitor, 0402 Package
C2, C4, C6	4.7μF Tantalum Capacitor
C1	68µF Tantalum Capacitor
R1	0Ω Resistor, 0603 Package
P1, P2	4-PIN DC connector
J1, J2, J3, J4	PCB mount SMA connector
PCB	VC183x410(D)